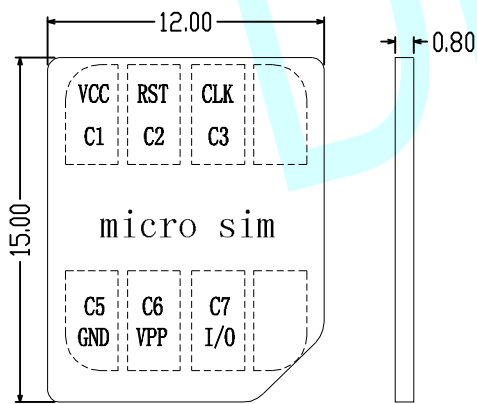
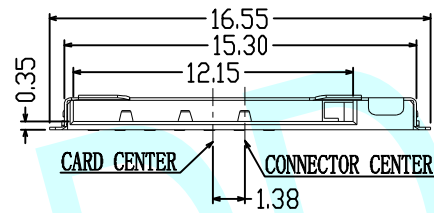
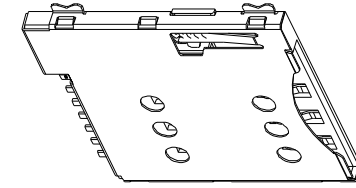
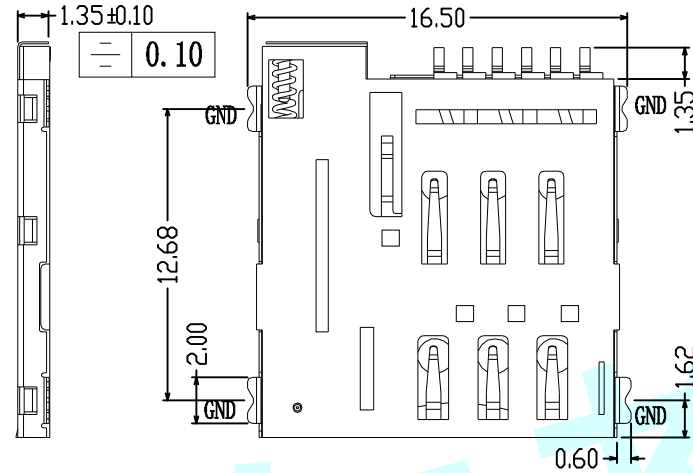
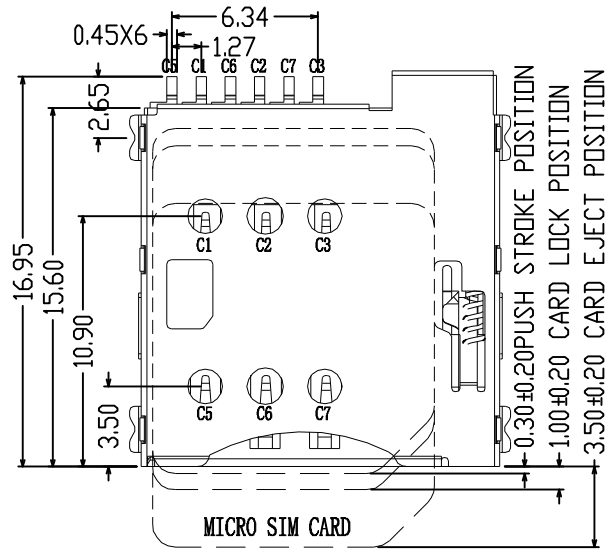
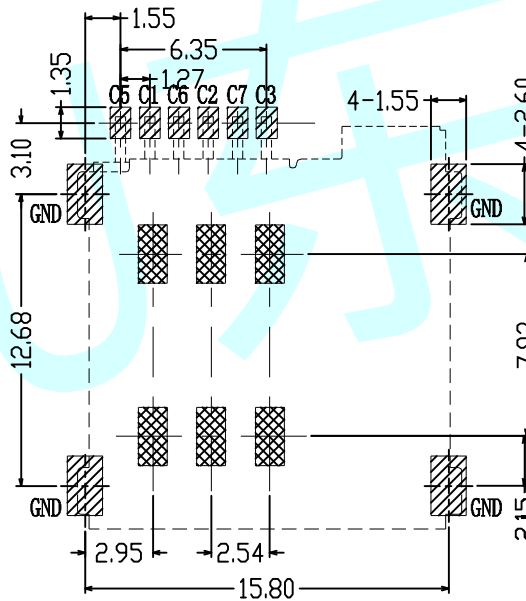


ROHS



- C1:VCC
- C2:RST
- C3:CLK
- C4:RESERVED
- C5:GND
- C6:VPP
- C7:I/O
- C8:RESERVED



CIRCUIT TRACE KEEP OUT AREA
 SMT SOLDER AREA

THERE SHOULD NOT BE ANY CIRCUITRIES IN THE LAYOUT SPACE OF THE PRODUCTS.

RECOMMENDED PCB LAYOUT
GENERAL TOLERANCE ±0.05

SPECIFICATION:

1. Material:
 - a. Insulator: High temperature thermoplastic, UL 94V-0
 - b. Contact: Copper alloy
2. Plating:
 - a. Contact: Plated 50u" Ni overall contact Au lu
 - b. Shell: Plated 50u" Ni overall
3. Electrical:
 - a. Current Rating: 0.5mA ac/dc max
 - b. Voltage Rating: 125V AC/DC
 - c. Ambient Temperature Range: -20°C~+60°C
 - d. Storage Temperature Range: -40°C~+70°C
 - e. Ambient Humidity Range: 95% R.H. max
 - f. Contact Resistance: 100mΩ max
 - g. Insulation Resistance: 1000MΩ min/500V DC
 - h. Mating Cycles: 10,000 Insertions

Product temperature resistance: 260°C \S (1.70) °C \S (1.70) +5°C -5°C

APPROVALS		DATE	http://www.dongdudz.com		
DRAW:	ZRD	2017-12-6	TOLERANCE:	ANGLE:	
CHECKED:	***	****	30≥	±0.30	
APPROVALS:	***	****	10°30	±0.20	
			5°10	±0.15	
			≤5	±0.10	
			±2°	东都电子 DONGDU ELECTRONICS	
				MODL:	CASSETTE
				PART NO:	SIM-06P
				UNIT :mm	SCALE:1:1
			REV:	A	
				PAGE:1/1	